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TFT | OLED | CHARACTER | GRAPHIC | UWVD | SEGMENT | CUSTOM

Character Display Module

Part Number

C164A1-BW-XW63

Overview:

- 16x4 Character LCD
- STN Blue Negative
- 87.0x60.0mm Module
- 4-bit or 8-bit Parallel Interface(s)
- White LED Backlight
- Transmissive
- Wide Temperature Range
- 3.3V
- LCD IC: ST7066U-0A
- RoHS Compliant

Character LCD Features

Characters: 16x4

Interface(s): 4-bit or 8-bit Parallel

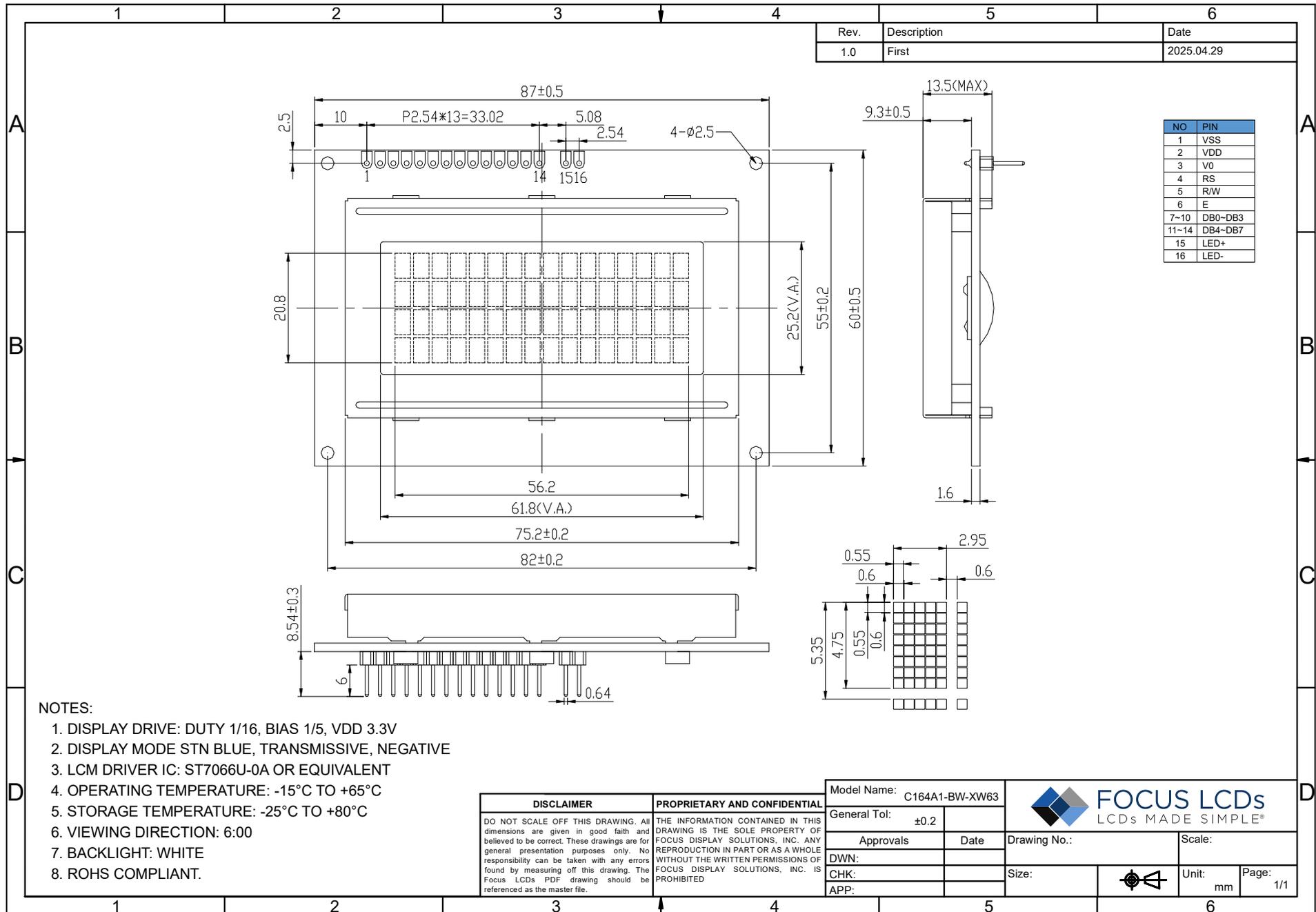
RoHS Compliant

General Information Items	Specification	Unit	Note
	Main Panel		
Viewing Area (VA)	61.8 (H) x 25.2 (V)	mm	--
LCD Type	STN Negative	--	--
Viewing Angle	6:00	O'Clock	--
Polarizer	Transmissive	--	--
Backlight Type	LED	--	--
Backlight Color	White	--	--
LCD IC	ST7066U-0A	--	--
Character Height	4.75	mm	--
Operating Temperature	-15 to +65	°C	--
Storage Temperature	-25 to +80	°C	--

Mechanical Information

Item		Min.	Typ.	Max.	Unit	Note
Module Size	Horizontal (H)	--	87.0	--	mm	--
	Vertical (V)	--	60.0	--	mm	--
	Depth (D)	--	13.5	--	mm	--
Weight		--	58.90	--	g	Approximate

1. Outline Dimensions



2. Input Terminal Pin Assignment

NO.	Symbol	Description	I/O
1	VSS	Signal ground for LCM (GND).	P
2	VDD	Power supply for logic (+3.3V) for LCM.	P
3	V0	Contrast adjust.	I
4	RS	Register select signal.	I
5	R/W	Read/write select signal.	I
6	E	Operation (data read/write) enable signal.	I
7-10	DB0~DB3	Four low order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCM. These four are not used during 4-bit operation.	I/O
11-14	DB4~DB7	Four high order bi-directional three-state data bus lines. Used for data transfer between the MPU.	I/O
15	LED+	Power supply for backlight (+3.3V).	P
16	LED-	Power supply for backlight (GND).	P

I: Input, O: Output, S: Supply

3. LCD Optical Characteristics

Item	Symbol	Condition	Min	Typ.	Max	Unit	
Contrast Ratio	CR	--	--	10	--		
Response Time	On	T_{on}	--	200	250	ms	
	Off	T_{off}	--	300	350	ms	
Viewing Angle CR \geq 3, 25°C	Hor.	Θ_L	$\Phi=270^\circ, 9H$	--	35	--	degree
		Θ_R	$\Phi=90^\circ, 3H$	--	35	--	
	Ver.	Θ_T	$\Phi=180^\circ, 12H$	--	20	--	
		Θ_B	$\Phi=0^\circ, 6H$	--	40	--	

4. Electrical Characteristics

4.1 Absolute Maximum Rating

Characteristics	Symbol	Min	Max	Unit
Supply Voltage	VDD-VSS	-0.3	6.0	V
	VDD-V0	3.0	7.0	V
Operating Temperature	TOP	-15	+65	°C
Storage Temperature	TST	-25	+80	°C

NOTE: If the absolute maximum rating of the above parameters is exceeded, even momentarily, the quality of the product may be degraded. Absolute maximum ratings specify the values which the product may be physically damaged if exceeded. Be sure to use the product within the range of the absolute maximum ratings.

4.2 DC Electrical Characteristics

Characteristics	Symbol	Condition	Min	Typ.	Max	Unit
Supply Voltage for LCD	VDD-V0	Ta=25°C	--	3.1	--	V
Input Voltage	VDD	--	--	3.3	--	V
Backlight Supply Voltage	H Level	VIH	--	0.7VDD	--	VDD
	L Level	VIL	--	-0.3	--	0.6
	H Level	VOH	--	0.75 VDD	--	--
	L Level	VOL	--	--	--	0.2 VDD

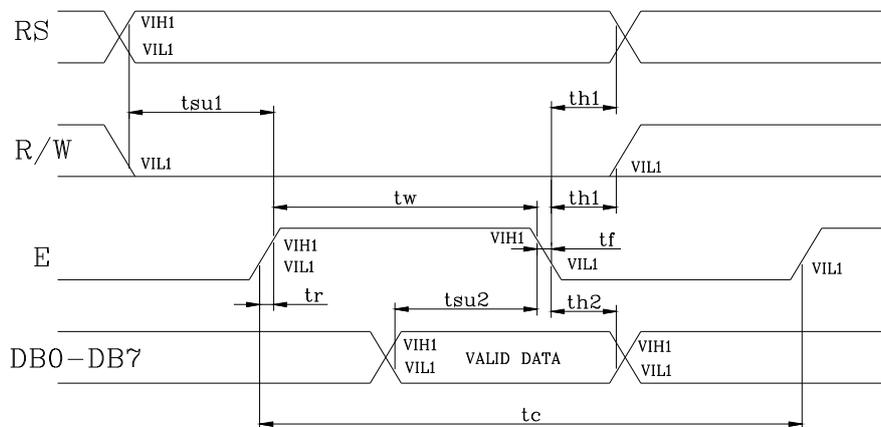
Condition:

1. VDD = 3.3V
2. 1/16 Duty, 1/5 Bias

5. Timing Characteristics

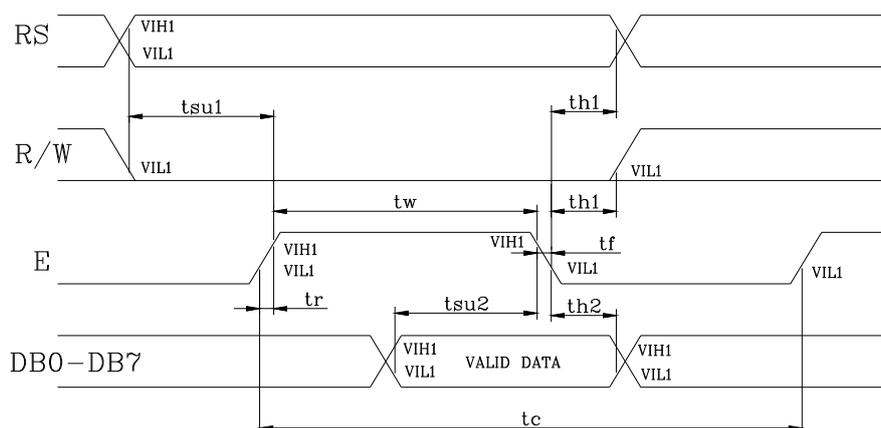
Write Cycle (Ta=25°C, VDD=3.3V)

Parameter	Symbol	Min	Typ.	Max	Unit	Test Pin
Enable Cycle Time	tc	1200	--	--	ns	E
Enable Pulse Width	tw	460	--	--	ns	
Enable Rise/Fall Time	tr, tf	--	--	25	ns	
RS, R/W Setup Time	tsu1	10	--	--	ns	RS, RW
RS, R/W Address Hold Time	th1	20	--	--	ns	
Data Setup Time	tsu2	90	--	--	ns	DB0-DB7
Data Hold Time	th2	10	--	--	ns	



Read Cycle (Ta=25°C, VDD=3.3V)

Parameter	Symbol	Min	Typ.	Max	Unit	Test Pin
Enable Cycle Time	tc	1200	--	--	ns	E
Enable Pulse Width	tw	480	--	--	ns	
Enable Rise/Fall Time	tr, tf	--	--	25	ns	
RS, R/W Setup Time	tsu	10	--	--	ns	RS, RW
RS, R/W Address Hold Time	th	20	--	--	ns	
Data Setup Time	td	--	--	360	ns	DB0-DB7
Data Hold Time	tdh	10	--	--	ns	

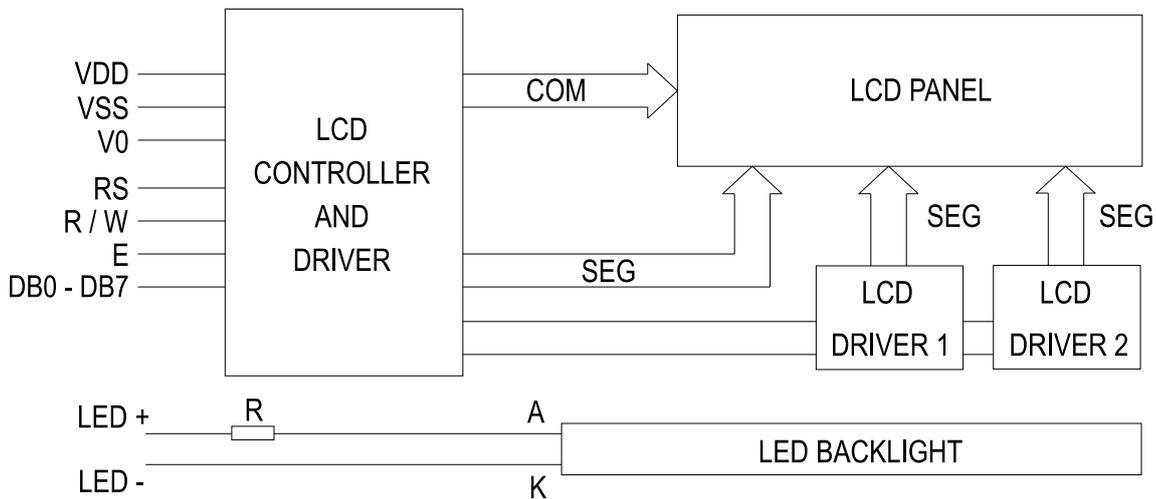


6. Backlight Characteristics

Unless specified, the ambient temperature $T_a=25^{\circ}\text{C}$.

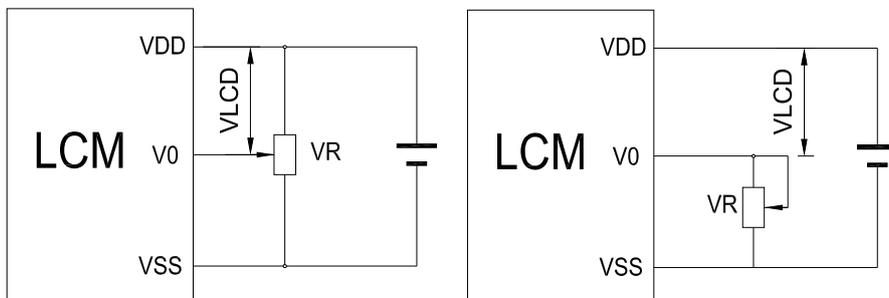
Characteristics	Symbol	Min	Typ.	Max	Unit
Forward Voltage	V_F	2.8	3.0	3.2	v
Forward Current	I_F	--	10	15	mA
Power	P	--	--	0.2	W
Peak Wave Length	λ_p	--	---	--	nm
Luminance	L_v	--	60	--	Cd/m ²
Operating Temperature Range	T_{OP}	-20	-	+70	$^{\circ}\text{C}$
Storage Temperature Range	T_{ST}	-25	-	+80	$^{\circ}\text{C}$

7. Block Diagram



8. Contrast Adjusting Circuit

For single source.



$V_{DD}-V_0$: LCD Driving Voltage

VR: 10k-20k

9. Instructions

To overcome the speed difference between the internal clock of ST7066 (or equivalent) and the MPU clock, ST7066 performs internal operations by storing control in formations to IR or DR. The internal operation is determined according to the signal from MPU, composed of read/write and data bus. Instructions can be divided largely into four groups:

- 1) ST7066 function set instructions (set display methods, set data length, etc.)
- 2) Address set instructions to internal RAM
- 3) Data transfer instructions with internal RAM
- 4) Others

The address of the internal RAM is automatically increased or decreased by 1.

Note: during internal operation, busy flag (DB7) is read "High". Busy flag check must be preceded by the next instruction.

9.1 Instruction Table

Instruction	Instruction Code										Description	Exc.Time (f _{osc} =270KHz)	
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
Clear Display	0	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC.	1.53 ms
Return Home	0	0	0	0	0	0	0	0	0	1	--	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53 ms
Entry Mode Set	0	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	39 μs
Display ON/OFF	0	0	0	0	0	0	0	1	D	C	B	D=1:entire display on C=1:cursor on B=1:cursor position on	
Cursor or Display Shift	0	0	0	0	0	0	1	S/C	R/L	--	--	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	39 μs
Function Set	0	0	0	0	0	1	DL	N	F	--	--	DL:interface data is 8/4 bits N:number of line is 2/1 F:font size is 5x11/5x8	39 μs
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0		Set CGRAM address in address counter	39 μs
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0		Set DDRAM address in address counter	39 μs
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0		Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 us
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0		Write data into internal RAM (DDRAM/CGRAM).	43 μs
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0		Read data from internal RAM (DDRAM/CGRAM)	43 μs

NOTE: When an MPU program with checking the busy flag (DB7) is made, it must be necessary 1/2f_{osc} is necessary for executing the next instruction by the falling edge of the "E" signal after the busy flag (DB7) goes to "Low".

9.2 Contents

9.2.1. Clear Display

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	0	1

Clear all the display data by writing "20H" (space code) to all DDRAM address, and set DDRAM address to "00H" into AC (address counter). Return cursor to the original status, namely, bring the cursor to the left edge on first line of the display. Make entry mode increment (I/D = "High").

9.2.2. Return Home

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	1	-

Return Home is cursor return home instruction. Set DDRAM address to "00H" into the address counter. Return cursor to its original site and return display to its original status, if shifted. Contents of DDRAM does not change.

9.2.3. Entry Mode Set

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	1	I/D	SH

Set the moving direction of cursor and display.

I/D: Increment / decrement of DDRAM address (cursor or blink)

When I/D = "High", cursor/blink moves to right and DDRAM address is increased by 1.

When I/D = "Low", cursor/blink moves to left and DDRAM address is decreased by 1.

* CGRAM operates the same as DDRAM, when read from or write to CGRAM.

SH: Shift of entire display

When DDRAM read (CGRAM read/write) operation or SH = "Low", shift of entire display is not performed. If SH = "High" and DDRAM write operation, shift of entire display is performed according to I/D value (I/D = "High" : shift left, I/D = "Low" : shift right).

9.2.4. Display ON/OFF

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	1	D	C	B

Control display/cursor/blink ON/OFF 1 bit register.

D: Display ON/OFF control bit

When D = "High", entire display is turned on.

When D = "Low", display is turned off, but display data is remained in DDRAM.

C: Cursor ON/OFF control bit

When C = "High", cursor is turned on.

When C = "Low", cursor is disappeared in current display, but I/D register remains its data.

B: Cursor Blink ON/OFF control bit

When B = "High", cursor blink is on, that performs alternately between all the high data and display character at the cursor position.

When B = "Low", blink is off.

When 1-line display mode (N = Low), DDRAM address is from "00H" to "4FH".

In 2-line display mode (N = High), DDRAM address in the 1st line is from "00H" to "27H", and DDRAM address in the 2nd line is from "40H" to "67H".

9.2.9. Read Busy Flag and Address

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0

This instruction shows whether ST7066U is in internal operation or not. If the resultant BF is "High", internal operation is in progress and should wait BF is to be LOW, which by then the next instruction can be performed. In this instruction you can also read the value of the address counter.

9.2.10. Write Data to RAM

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	D7	D6	D5	D4	D3	D2	D1	D0

Write binary 8-bit data to DDRAM/CGRAM.

The selection of RAM from DDRAM, CGRAM, is set by the previous address set instruction: DDRAM address set, CGRAM address set. RAM set instruction can also determine the AC direction to RAM.

After write operation, the address is automatically increased/decreased by 1, according to the entry mode.

9.2.11. Read Data from RAM

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0

Read binary 8-bit data from DDRAM/CGRAM.

The selection of RAM is set by the previous address set instruction. If the address set instruction of RAM is not performed before this instruction, the data that has been read first is invalid, as the direction of AC is not yet determined. If RAM data is read several times without RAM address instructions set before, read operation, the correct RAM data can be obtained from the second. But the first data would be incorrect, as there is no time margin to transfer RAM data.

In case of DDRAM read operation, cursor shift instruction plays the same role as DDRAM address set instruction, it also transfers RAM data to output data register.

After read operation, address counter is automatically increased/decreased by 1 according to the entry mode.

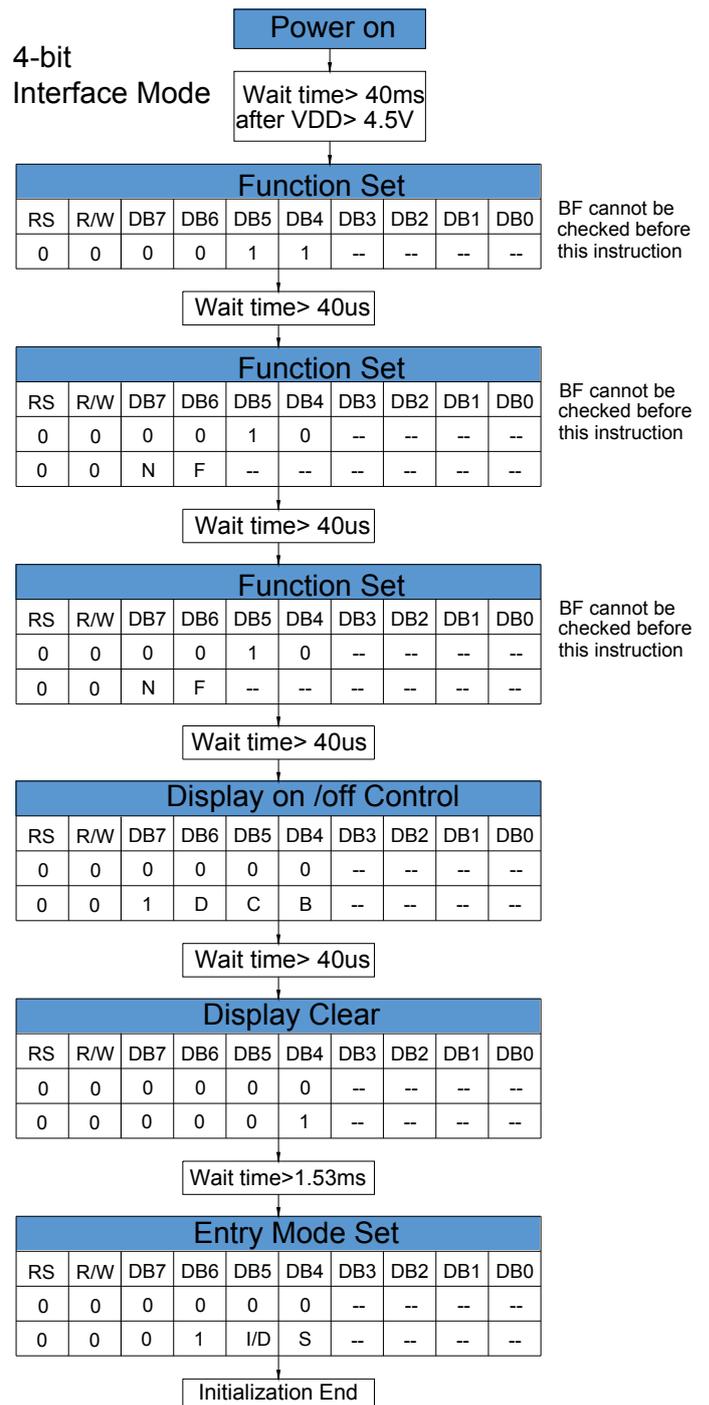
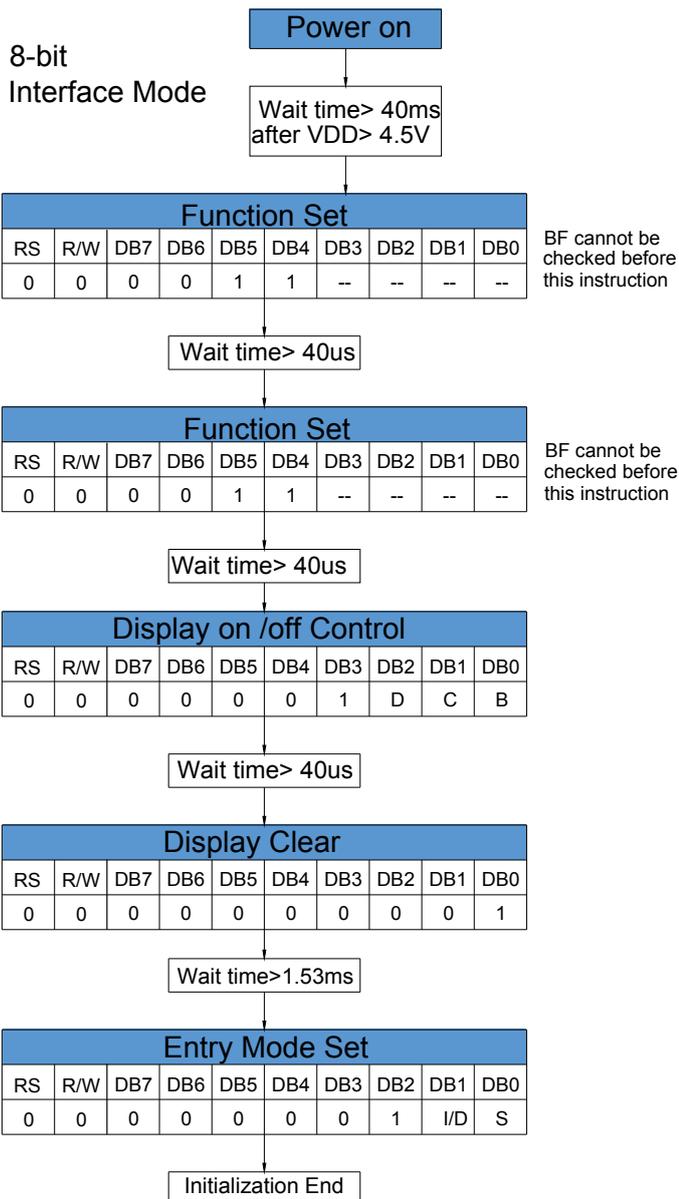
After CGRAM read operation, display shift may not be executed correctly.

NOTE: In case of RAM write operation, AC is increased/decreased by 1 as in read operation. At this time, AC indicates next address position, but only the previous data can be read by the read instruction.

10. Standard Character Pattern

Upper 4bit Lower 4bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	HHHH
LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
HLHH	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
HHHH	(8)															

11. Initializing By Instruction



12. Cautions and Handling

General Precautions:

1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isopropyl alcohol, ethyl alcohol or trichlorotrifluoroethane. Do not use water, ketone or aromatics and never scrub hard.
3. Do not tamper in any way with the tabs on the metal frame.
4. Do not make any modification on the PCB without consulting.
5. When mounting the LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and cause rainbow on the display.
7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

1. CMOS-LSI is used for the module circuit; therefore, operators should be grounded whenever he/she comes into contact with the module.
2. Do not touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
5. Only properly grounded soldering irons should be used.
6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
7. The normal static prevention measures should be observed for work clothes and working benches.
8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

1. Soldering should be performed only on the I/O terminals.
2. Use soldering irons with proper grounding and no leakage.
3. Soldering temperature: $280^{\circ}\text{C}+10^{\circ}\text{C}$
4. Soldering time: 3 to 4 seconds.
5. Use eutectic solder with resin flux filling.
6. If flux is used, the LCD surface should be protected to avoid spattering flux.
7. Flux residue should be removed.

Operation Precautions:

1. The viewing angle can be adjusted by varying the LCD driving voltage V_o .
2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
4. Response time increases with decrease in temperature.
5. Display color may be affected at temperatures above its operational range.
6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
7. For long-term storage under 40°C is required and the relative humidity should be kept below 60%.